

# P-Channel Enhancement Mode MOSFET

## 1. Product Information

### 1.1 Features

- ☒ Advanced trench cell design
- ☒ Low Thermal Resistance

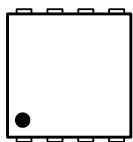
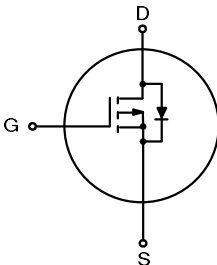
### 1.2 Applications

- ☒ Motor drivers
- ☒ DC - DC Converter

### 1.3 Quick reference

- ☒  $BV \geq -20V$
- ☒  $P_{tot} \leq 50 W$
- ☒  $I_D \leq -90 A$
- ☒  $R_{DS(ON)} \leq 4.5 m\Omega @ V_{GS} = -4.5 V$
- ☒  $R_{DS(ON)} \leq 6.5 m\Omega @ V_{GS} = -2.5 V$
- ☒  $R_{DS(ON)} \leq 9.5 m\Omega @ V_{GS} = -1.8 V$

## 2. Pin Description

| Pin     | Description | Simplified Outline                                                                                                | Symbol                                                                                |
|---------|-------------|-------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------|
| 1,2,3   | Source      | <br>Top View<br>PDFN3.3x3.3-8L |  |
| 4       | Gate        |                                                                                                                   |                                                                                       |
| 5,6,7,8 | Drain       |                                                                                                                   |                                                                                       |

### 3. Limiting Values

| Symbol                   | Parameter                               | Conditions                                        | Min  | Max  | Unit   |
|--------------------------|-----------------------------------------|---------------------------------------------------|------|------|--------|
| V <sub>DS</sub>          | Drain-Source Voltage                    | T <sub>C</sub> = 25 °C                            | -20  | -    | V      |
| V <sub>GS</sub>          | Gate-Source Voltage                     | T <sub>C</sub> = 25 °C                            | -    | ±12  | V      |
| I <sub>D</sub> *         | Drain Current                           | T <sub>C</sub> = 25 °C, V <sub>GS</sub> = -4.5 V  | -    | -90  | A      |
|                          |                                         | T <sub>C</sub> = 100 °C, V <sub>GS</sub> = -4.5 V | -    | -56  | A      |
| I <sub>DM</sub> *,**,*** | Pulsed Source Current                   | T <sub>C</sub> = 25 °C, V <sub>GS</sub> = -4.5V   | -    | -194 | A      |
| P <sub>tot</sub> *       | Total Power Dissipation                 | T <sub>C</sub> = 25 °C                            | -    | 20   | W      |
| T <sub>stg</sub>         | Storage Temperature                     |                                                   | - 55 | 150  | °C     |
| T <sub>J</sub>           | Junction Temperature                    |                                                   | -    | 150  | °C     |
| I <sub>S</sub>           | Diode Forward Current                   | T <sub>C</sub> = 25 °C                            | -    | -90  | A      |
| E <sub>AS</sub> *        | Single Pulsed Avalanche Energy          | V <sub>DD</sub> = -20V , L= 1 mH                  | -    | 564  | mJ     |
| R <sub>θJC</sub> *       | Thermal Resistance- Junction to Ambient |                                                   | -    | 6    | °C / W |

Notes :

\* Surface Mounted on 1 in<sup>2</sup> pad area, t ≤ 10 sec

\*\* Pulse width ≤ 10 μs, duty cycle ≤ 1 %

\*\*\* Limited by bonding wire

### 4. Marking Information

| Product Name | Marking                                                          |
|--------------|------------------------------------------------------------------|
| N90P02Q      | <div>90P02</div> <div>YWWXXX</div> <div>YWW:<br/>Date Code</div> |

### 5. Ordering Code

| Product Name | Package        | Reel Size | Tape width | Quantity | Note |
|--------------|----------------|-----------|------------|----------|------|
| N90P02Q      | PDFN3.3*3.3-8L |           |            | 2500     |      |

Note: JSHD defines “ Green ” as lead-free ( RoHS compliant ) and halogen free ( Br or Cl does not exceed 900 ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500 ppm by weight; Follow IEC 61249-2-21 and IPC / JEDEC J-STD-020C )

## 6. Electrical Characteristics (T<sub>C</sub> = 25 °C Unless Otherwise Noted)

| Symbol                                   | Parameter                        | Conditions                                                                                                                  | Min  | Typ  | Max  | Unit |
|------------------------------------------|----------------------------------|-----------------------------------------------------------------------------------------------------------------------------|------|------|------|------|
| Static Characteristics                   |                                  |                                                                                                                             |      |      |      |      |
| BV <sub>DSS</sub>                        | Drain-Source Breakdown Voltage   | V <sub>GS</sub> = 0 V, I <sub>D</sub> = -250 μA                                                                             | -20  | -    | -    | V    |
| V <sub>GS(th)</sub>                      | Gate Threshold Voltage           | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>DS</sub> = -250 μA                                                               | -0.5 | -    | -1   | V    |
| I <sub>DSS</sub>                         | Zero Gate Voltage Source Current | V <sub>DS</sub> = -16V, V <sub>GS</sub> = 0 V                                                                               | -    | -    | -1   | μA   |
| I <sub>GSS</sub>                         | Gate Leakage Current             | V <sub>GS</sub> = ± 12V, V <sub>DS</sub> = 0 V                                                                              | -    | -    | ±100 | nA   |
| R <sub>DS(ON)</sub> <sup>a</sup>         | Drain-Source On-State Resistance | V <sub>GS</sub> = -4.5 V, I <sub>D</sub> = -10A                                                                             | -    | 3.8  | 4.5  | mΩ   |
|                                          |                                  | V <sub>GS</sub> = -2.5 V, I <sub>D</sub> = -5A                                                                              | -    | 5.5  | 6.5  | mΩ   |
|                                          |                                  | V <sub>GS</sub> = -1.8 V, I <sub>D</sub> = -3 A                                                                             | -    | 8.5  | 9.5  | mΩ   |
| Diode Characteristics                    |                                  |                                                                                                                             |      |      |      |      |
| V <sub>SD</sub> <sup>a</sup>             | Diode Forward Voltage            | I <sub>SD</sub> = -10A, V <sub>GS</sub> = 0 V                                                                               | -    | -    | -1.3 | V    |
| t <sub>rr</sub>                          | Reverse Recovery Time            | I <sub>SD</sub> = -10A, dI <sub>SD</sub> /dt = 100 A/μs                                                                     | -    | 45   | -    | nS   |
| Q <sub>rr</sub>                          | Reverse Recovery Charge          |                                                                                                                             | -    | 25   | -    | nC   |
| Dynamic Characteristics <sup>b</sup>     |                                  |                                                                                                                             |      |      |      |      |
| C <sub>iss</sub>                         | Input Capacitance                | V <sub>GS</sub> = 0 V, V <sub>DS</sub> = -10V<br>Frequency = 1 MHz                                                          | -    | 5008 | -    | pF   |
| C <sub>oss</sub>                         | Output Capacitance               |                                                                                                                             | -    | 614  | -    |      |
| C <sub>rss</sub>                         | Reverse Transfer Capacitance     |                                                                                                                             | -    | 499  | -    |      |
| t <sub>d(on)</sub>                       | Turn-on Delay Time               | V <sub>DS</sub> = -10V, V <sub>GEN</sub> = -4.5 V,<br>R <sub>G</sub> = 3.9 Ω, R <sub>L</sub> = 1Ω,<br>I <sub>D</sub> = -10A | -    | 7.8  | -    | nS   |
| t <sub>r</sub>                           | Turn-on Rise Time                |                                                                                                                             | -    | 42   | -    |      |
| t <sub>d(off)</sub>                      | Turn-off Delay Time              |                                                                                                                             | -    | 177  | -    |      |
| t <sub>f</sub>                           | Turn-off Fall Time               |                                                                                                                             | -    | 64   | -    |      |
| Gate Charge Characteristics <sup>b</sup> |                                  |                                                                                                                             |      |      |      |      |
| Q <sub>g</sub>                           | Total Gate Charge                | V <sub>DS</sub> = -10V, V <sub>GS</sub> = -4.5 V,<br>I <sub>DS</sub> = -10A                                                 | -    | 46   | -    | nC   |
| Q <sub>gs</sub>                          | Gate-Source Charge               |                                                                                                                             | -    | 14   | -    |      |
| Q <sub>gd</sub>                          | Gate-Drain Charge                |                                                                                                                             | -    | 10   | -    |      |

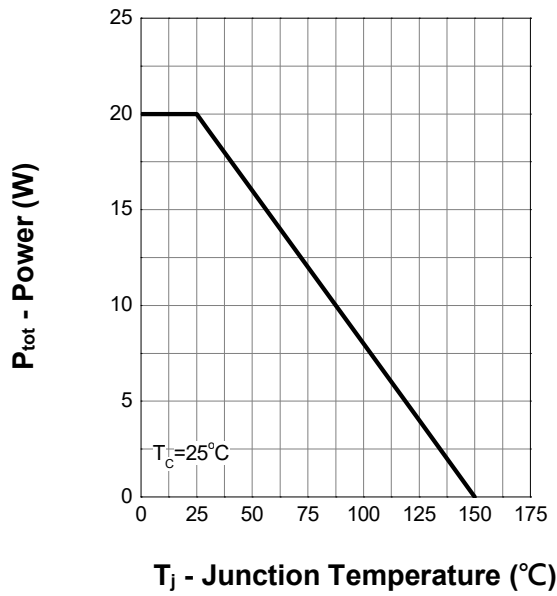
Notes :

a : Pulse test ; pulse width ≤ 300 μs, duty cycle ≤ 2 %

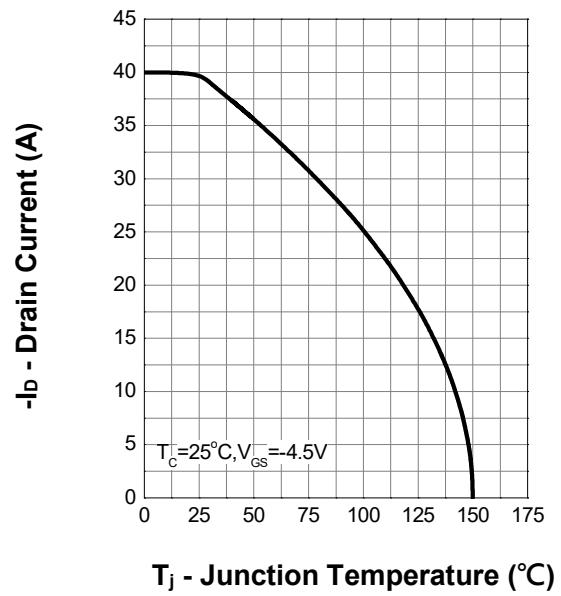
b : Guaranteed by design, not subject to production testing

## 7. Typical Characteristics

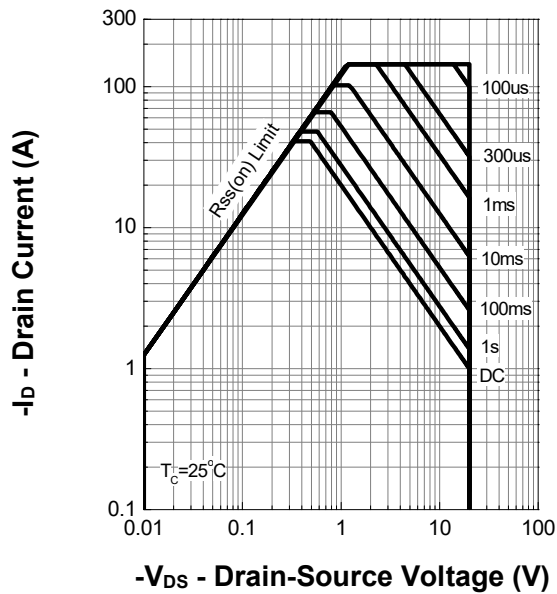
Power Capability



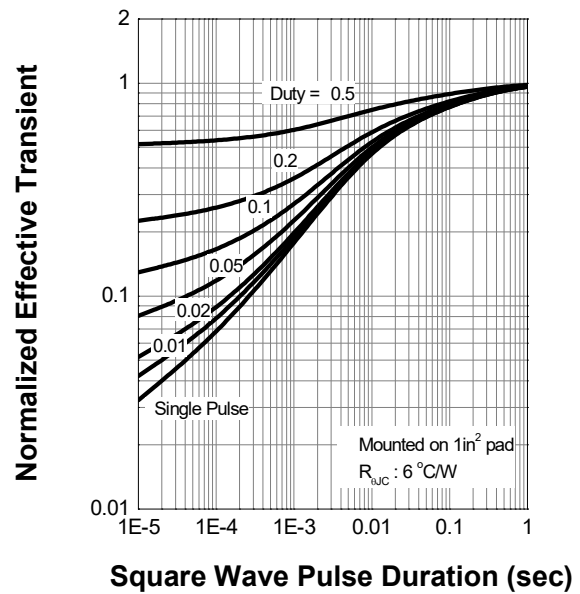
Current Capability



Safe Operation Area



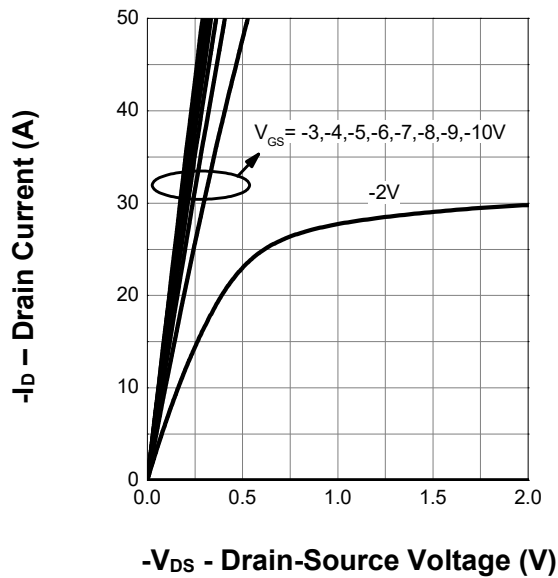
Thermal Transient Impedance



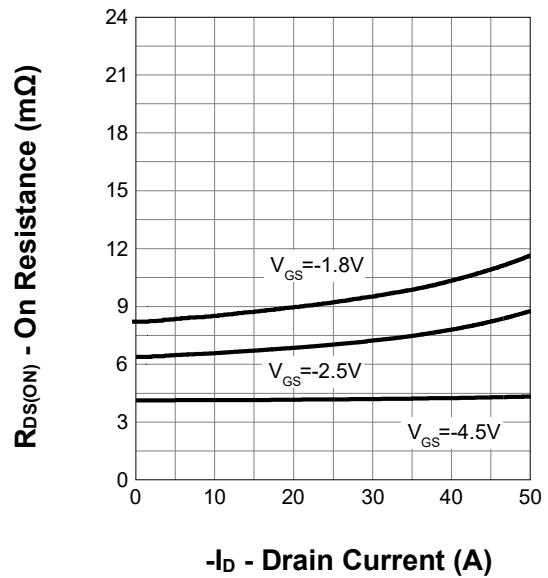


## 7. Typical Characteristics (cont.)

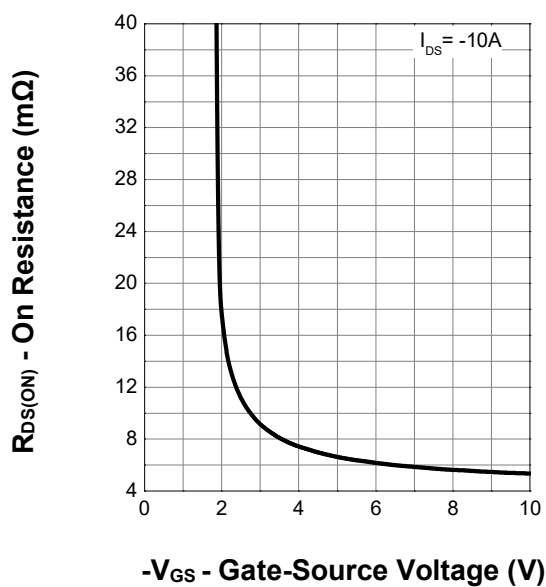
Output Characteristics



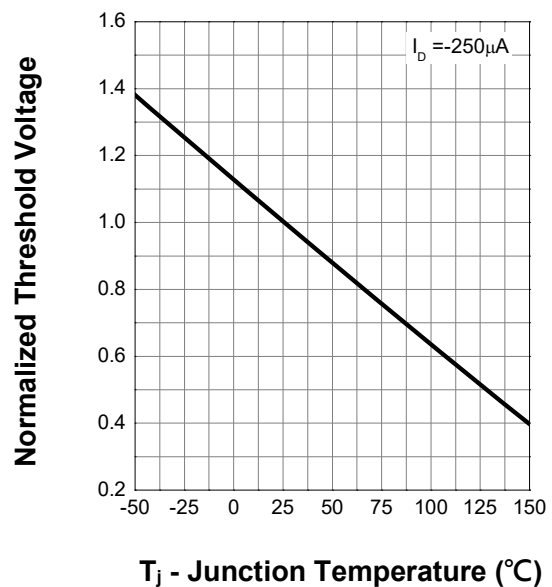
Drain-Source On Resistance



Transfer Characteristics

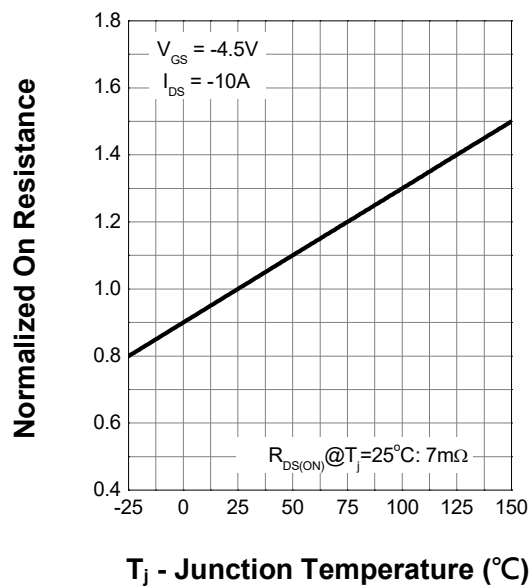


Gate Threshold Voltage

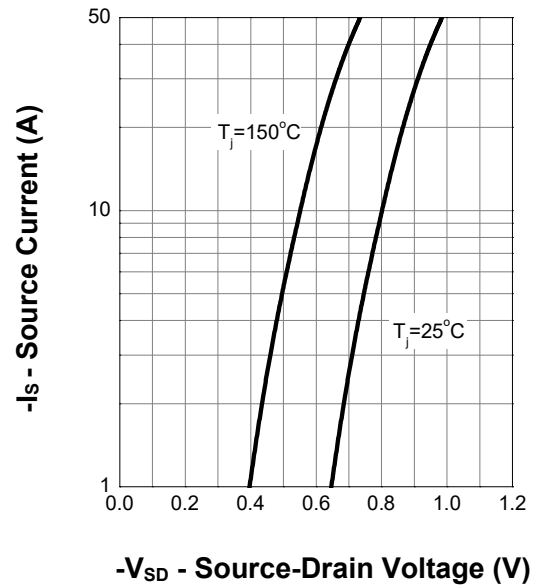


## 7. Typical Characteristics (cont.)

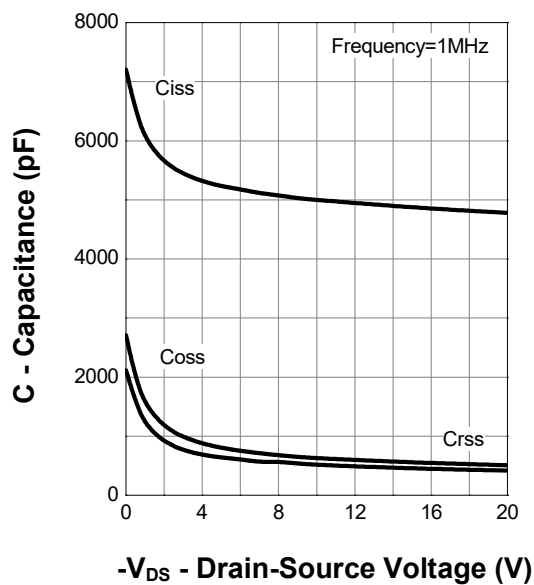
**Drain-Source On Resistance**



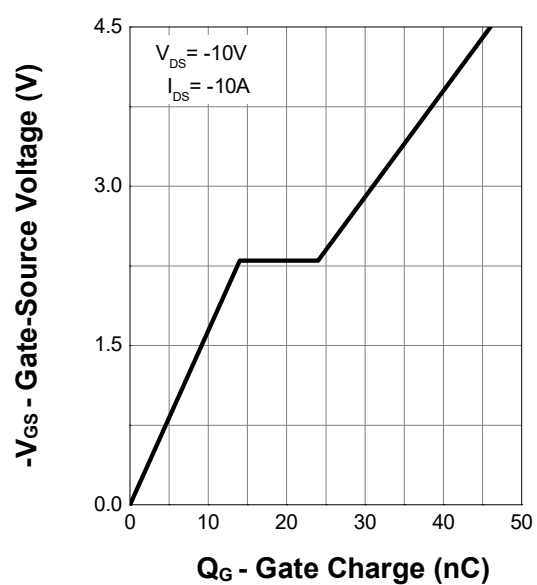
**Body Diode Characteristics**



**Capacitance**

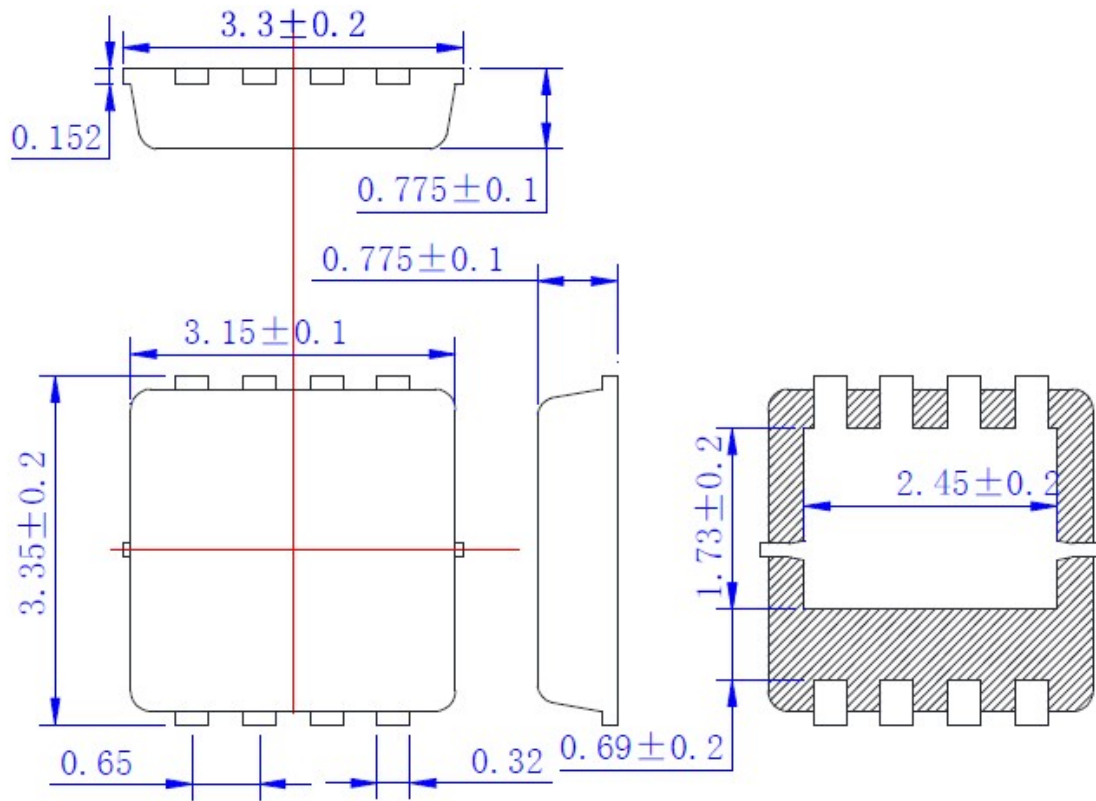


**Gate Charge**



## 8. Package Dimensions

PDFN3.3\*3.3-8L



### NOTICE

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